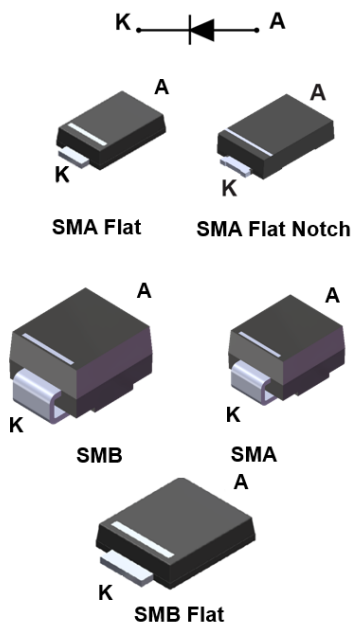


100 V, 2 A power Schottky rectifier



Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Avalanche capability specified
- ECOPACK2 component

Applications

- Switching diode
- Battery charger
- SMPS
- DC / DC converter
- Telecom power
- LED lighting

Description

This Schottky rectifier is designed for high frequency miniature switched mode power supplies such as adaptors and on board DC/DC converters.

Packaged in SMA, SMA Flat, SMB, SMB Flat and SMA Flat Notch, the STPS2H100 is ideal for use in lighting and telecom power applications.

Product status link

[STPS2H100](#)

Product summary

Symbol	Value
$I_{F(AV)}$	2 A
V_{RRM}	100 V
T_j (max.)	175 °C
V_F (max.)	0.65 V

1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter		Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		100	V	
$I_{F(AV)}$	Average forward current	SMA	$T_I = 130\text{ °C}, \delta = 0.5$	2	A
		SMB	$T_I = 135\text{ °C}, \delta = 0.5$		
		SMA Flat, SMA Flat Notch	$T_I = 145\text{ °C}, \delta = 0.5$		
		SMB Flat	$T_I = 150\text{ °C}, \delta = 0.5$		
I_{FSM}	Surge non repetitive forward current		$t_p = 10\text{ ms}$ sinusoidal	75	A
P_{ARM}	Repetitive peak avalanche power		$t_p = 10\text{ }\mu\text{s}, T_j = 125\text{ °C}$	173	W
T_{stg}	Storage temperature range		-65 to +175		°C
T_j	Maximum operating junction temperature ⁽¹⁾		175		°C

1. $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter		Max. value	Unit
$R_{th(j-l)}$	Junction to lead	SMA	30	°C/W
		SMA Flat, SMA Flat Notch	20	
		SMB	25	
		SMB Flat	15	

For more information, please refer to the following application note :

- AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$	-		1.00	μA
		$T_j = 125\text{ °C}$		-	0.40	1.00	mA
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 2\text{ A}$	-		0.79	V
		$T_j = 125\text{ °C}$		-	0.60	0.65	
		$T_j = 25\text{ °C}$	$I_F = 4\text{ A}$	-		0.88	
		$T_j = 125\text{ °C}$		-	0.69	0.74	

1. Pulse test: $t_p = 5\text{ ms}, \delta < 2\%$

2. Pulse test: $t_p = 380\text{ }\mu\text{s}, \delta < 2\%$

To evaluate the conduction losses, use the following equation:

$$P = 0.56 \times I_{F(AV)} + 0.045 \times I_{F(RMS)}^2$$

For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

1.1 Characteristics (curves)

Figure 1. Average forward power dissipation versus average forward current

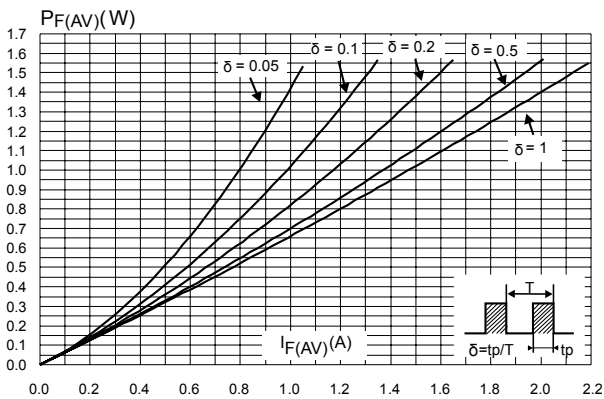


Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$, SMA / SMB)

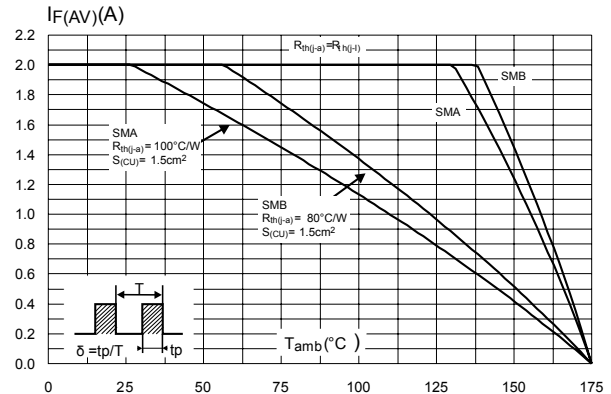


Figure 3. Average forward current versus ambient temperature ($\delta = 0.5$, SMB Flat)

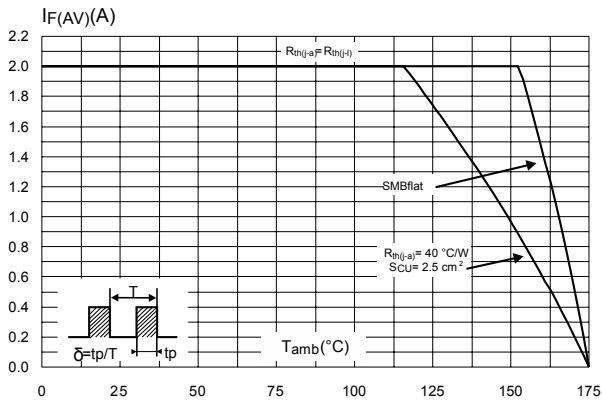


Figure 4. Average forward current versus ambient temperature ($\delta = 0.5$, SMA Flat, SMA Flat Notch)

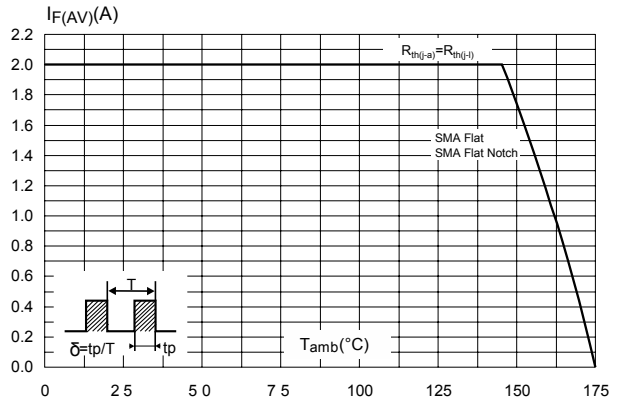


Figure 5. Normalized avalanche power derating versus junction temperature ($T_j = 125\text{ }^\circ\text{C}$)

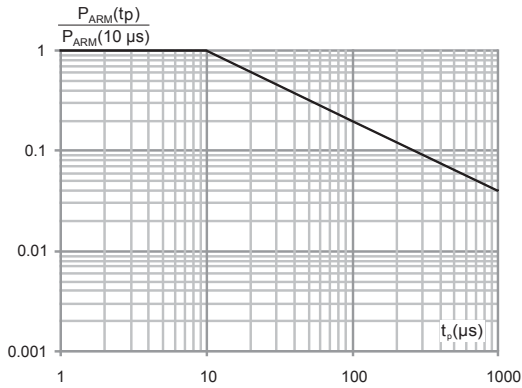


Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration (SMA)

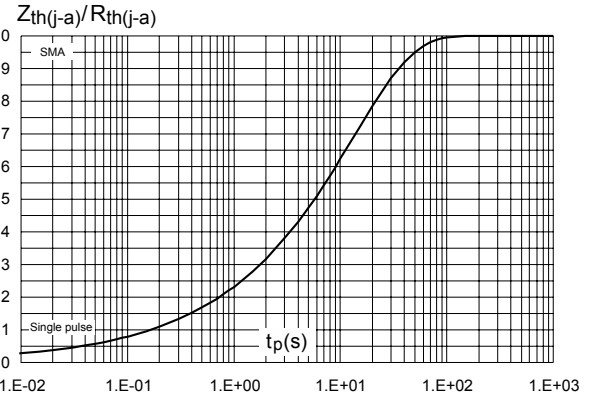


Figure 7. Relative variation of thermal impedance junction to lead versus pulse duration (SMA Flat, SMA Flat Notch)

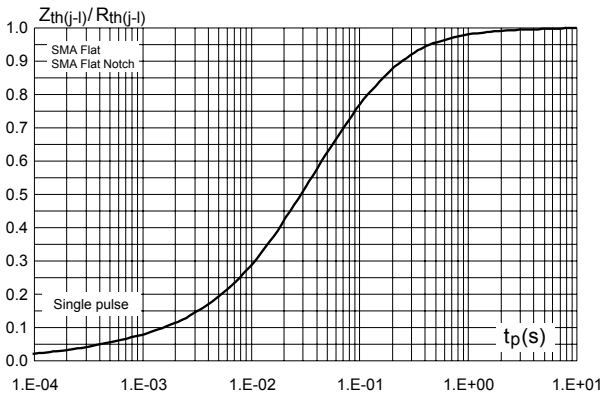


Figure 8. Relative variation of thermal impedance junction to ambient versus pulse duration (SMB)

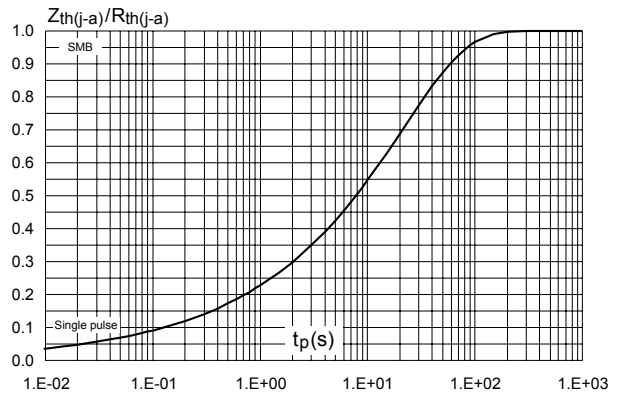


Figure 9. Relative variation of thermal impedance junction to lead versus pulse duration (SMB Flat)

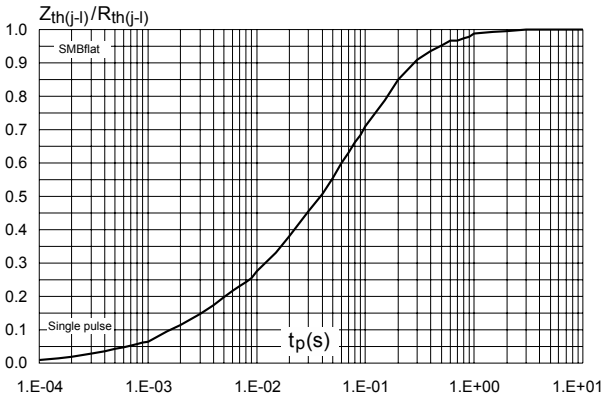


Figure 10. Reverse leakage current versus reverse voltage applied (typical values)

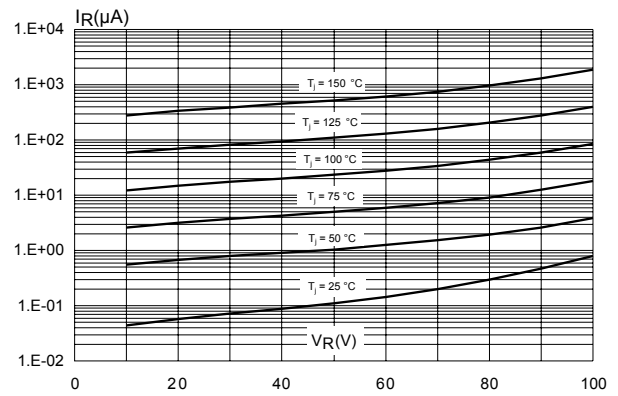


Figure 11. Junction capacitance versus reverse voltage applied (typical values)

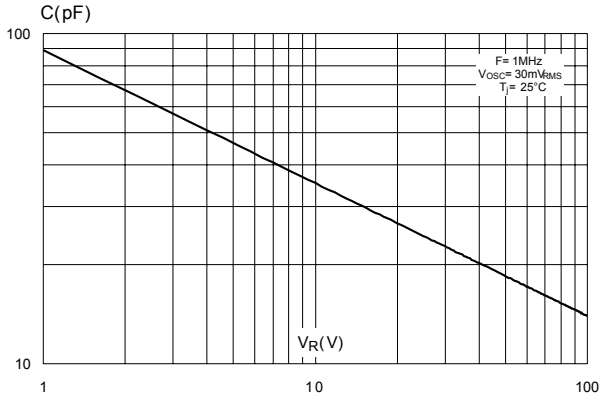


Figure 12. Forward voltage drop versus forward current (low level)

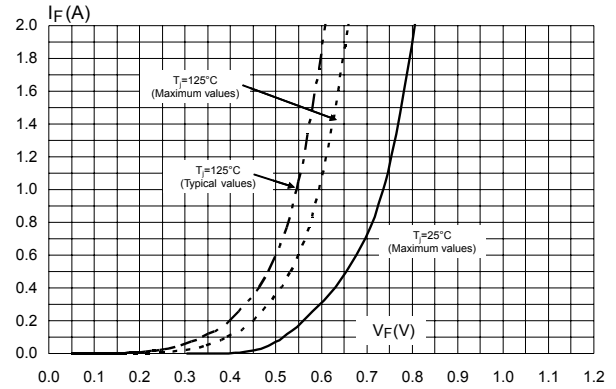


Figure 13. Forward voltage drop versus forward current (high level)

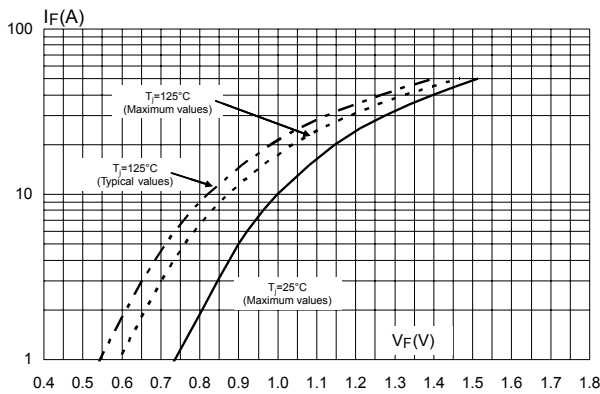


Figure 14. Thermal resistance junction to ambient versus copper surface under each lead (SMA)

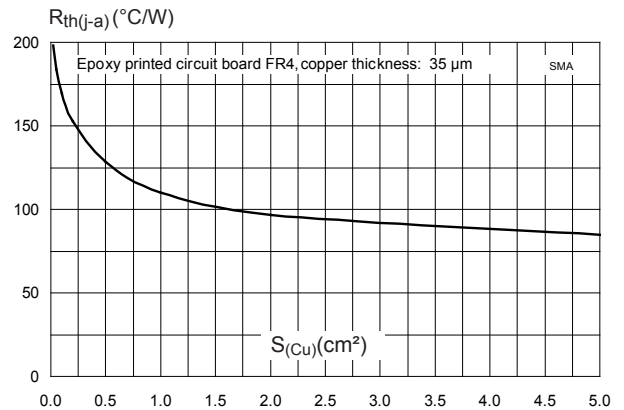


Figure 15. Thermal resistance junction to ambient versus copper surface under each lead (SMA Flat, SMA Flat Notch)

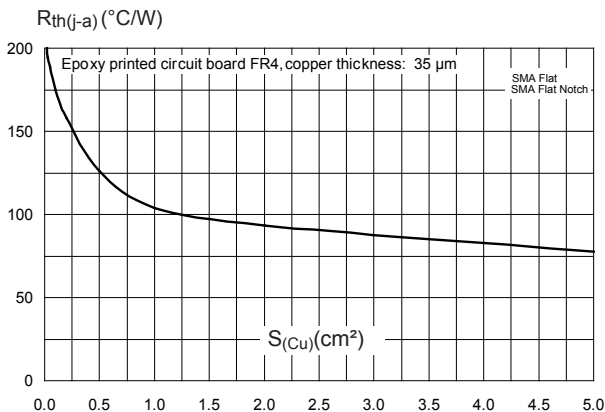


Figure 16. Thermal resistance junction to ambient versus copper surface under each lead (SMB)

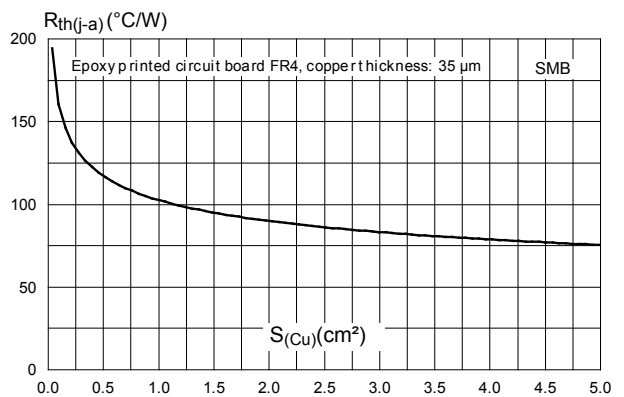
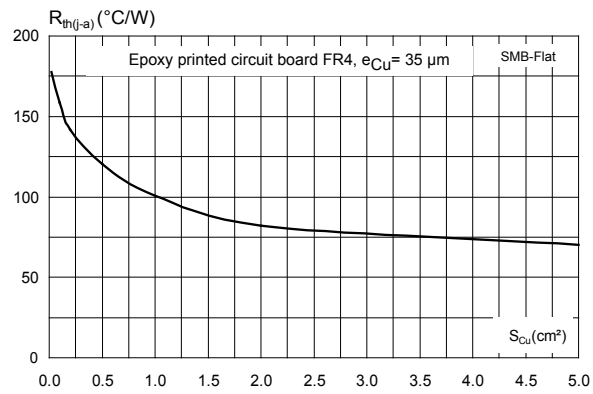


Figure 17. Thermal resistance junction to ambient versus copper surface under each lead (SMB Flat)



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMA Flat package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 18. SMA Flat package outline

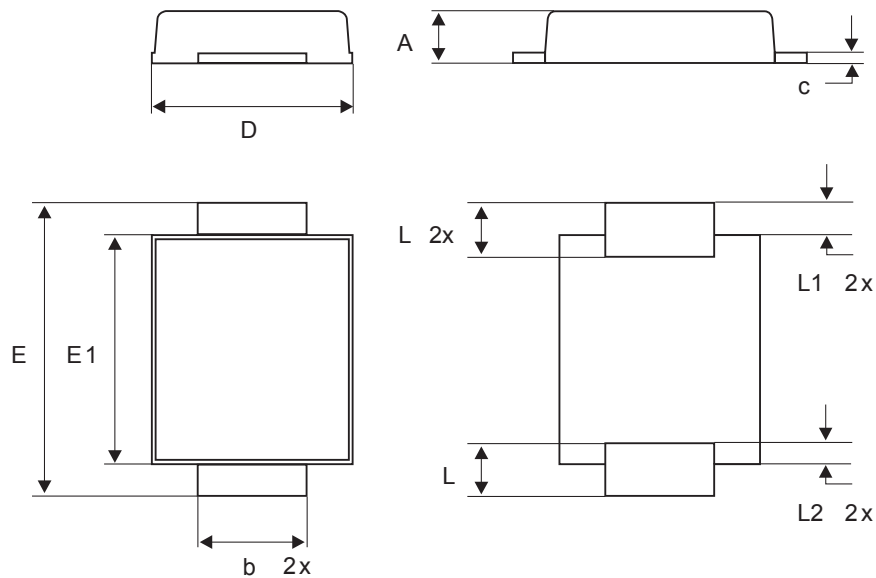
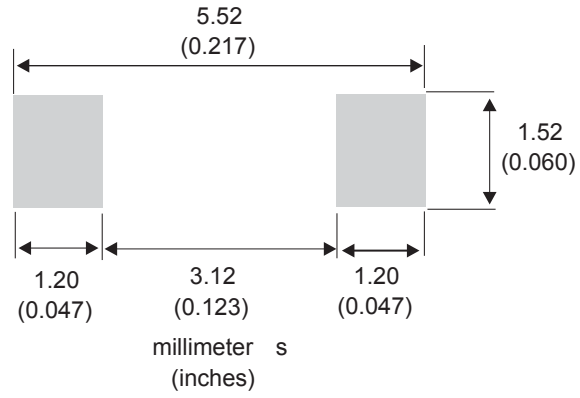


Table 4. SMA Flat package mechanical data

Ref.	Dimensions					
	Millimeters			Inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.10	0.035		0.044
b	1.25		1.65	0.049		0.065
c	0.15		0.40	0.005		0.016
D	2.25		2.95	0.088		0.117
E	4.80		5.60	0.188		0.221
E1	3.95		4.60	0.155		0.182
L	0.75		1.50	0.029		0.060
L1		0.50			0.020	
L2		0.50			0.020	

Figure 19. SMA Flat recommended footprint in mm (inches)



2.2 SMA Flat Notch package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Band indicates cathode

Figure 20. SMA Flat Notch package outline

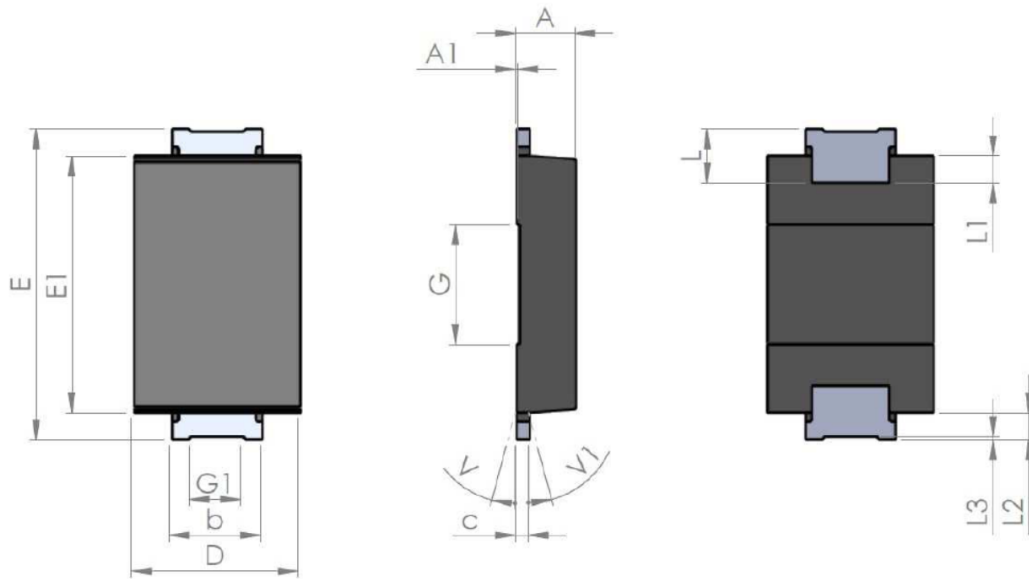
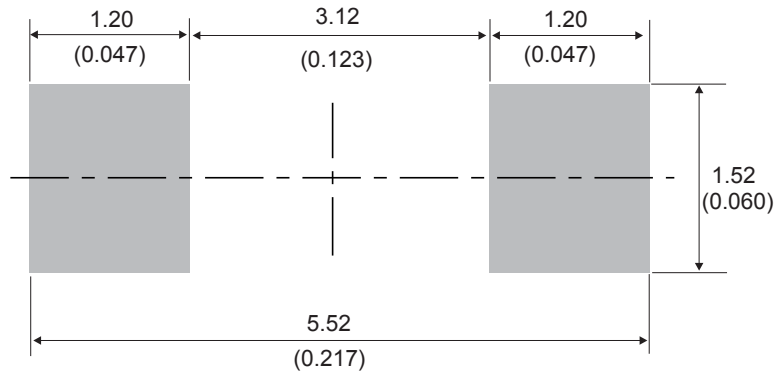


Table 5. SMA Flat Notch package mechanical data

Ref.	Dimensions					
	Millimeters			Inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A1	0.90		1.10	0.035		0.044
A1		0.05			0.002	
b	1.25		1.65	0.049		0.065
C	0.15		0.40	0.005		0.016
D	2.25		2.90	0.088		0.115
E	5.00		5.35	0.196		0.211
E1	3.95		4.60	0.155		0.182
G		2.00			0.079	
G1		0.85			0.033	
L	0.75		1.20	0.029		
L1		0.45			0.018	
L2		0.45			0.018	
L3		0.05			0.002	
V			8°			8°
V1			8°			8°

Figure 21. SMA Flat Notch recommended footprint in mm (inches)



2.3 SMA package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 22. SMA package outline

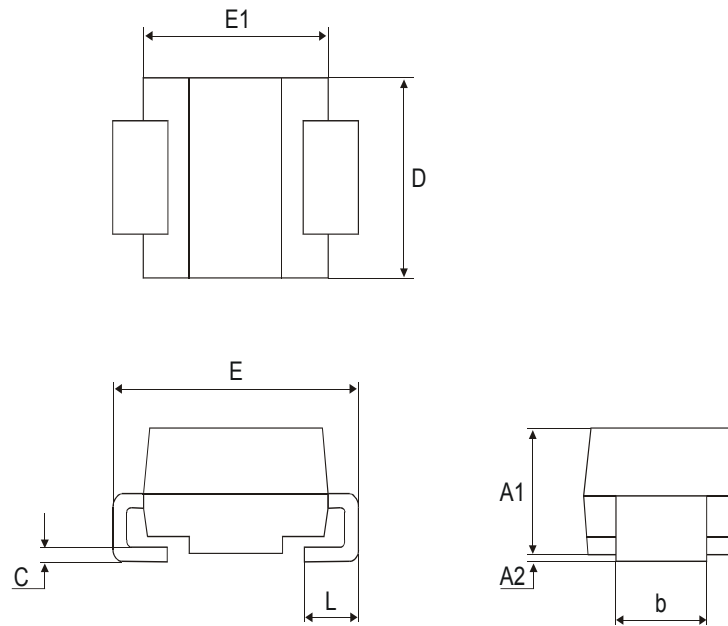
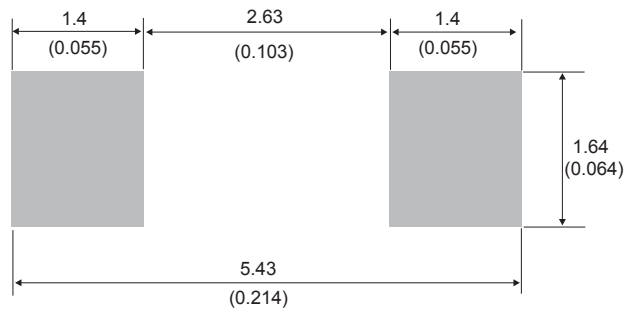


Table 6. SMA package mechanical data

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.097
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
c	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
E	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059

Figure 23. SMA recommended footprint in mm (inches)



2.4 SMB package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 24. SMB package outline

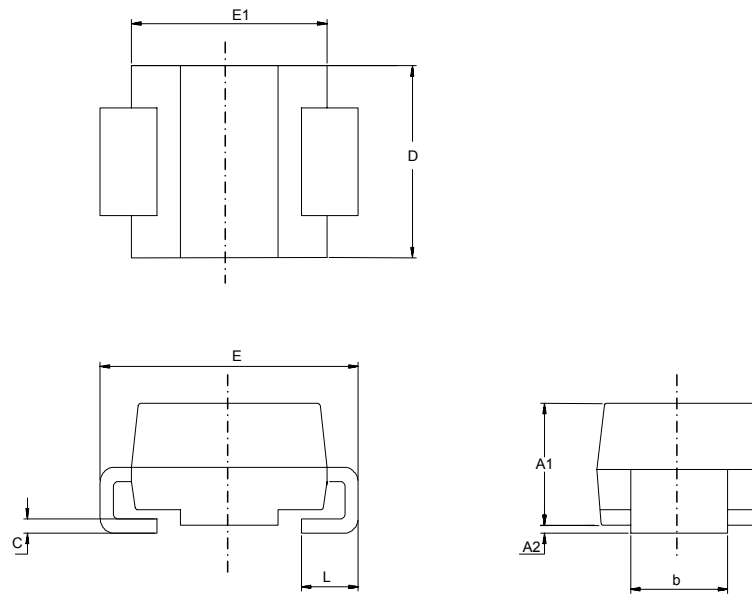
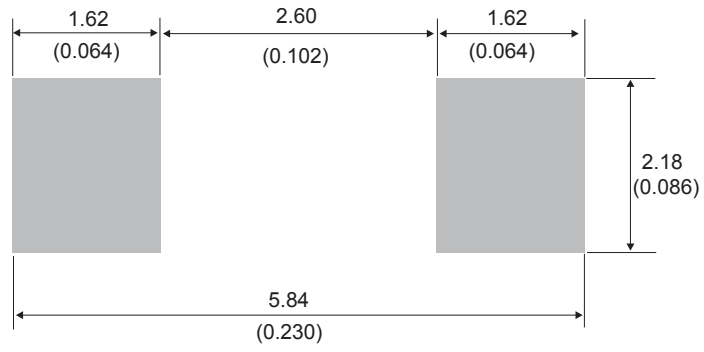


Table 7. SMB package mechanical data

Ref.	Dimensions			
	Millimeters		Inches (for reference only)	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.0748	0.0965
A2	0.05	0.20	0.0020	0.0079
b	1.95	2.20	0.0768	0.0867
c	0.15	0.40	0.0059	0.0157
D	3.30	3.95	0.1299	0.1556
E	5.10	5.60	0.2008	0.2205
E1	4.05	4.60	0.1594	0.1811
L	0.75	1.50	0.0295	0.0591

Figure 25. SMB recommended footprint



2.5 SMB Flat package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 26. SMB Flat package outline

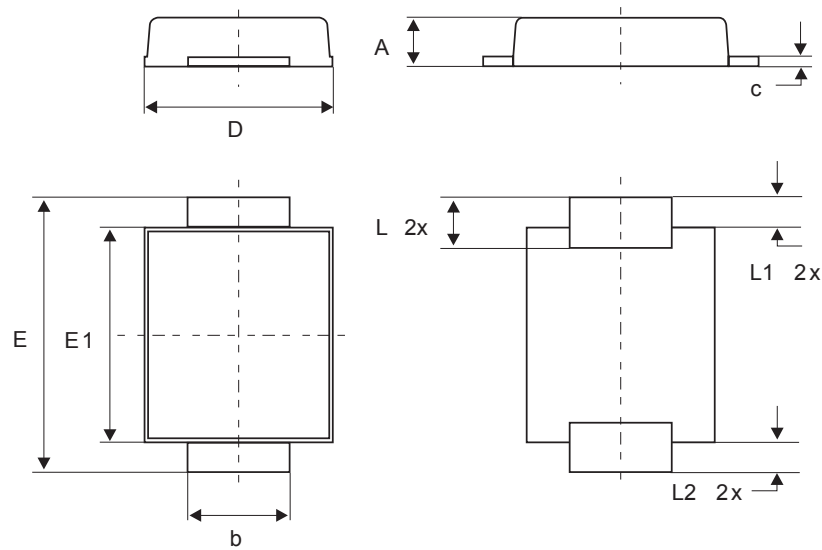
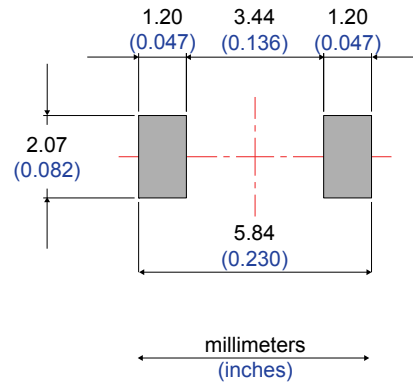


Table 8. SMB Flat mechanical data

Ref.	Dimensions					
	Millimeters			Inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.10	0.035		0.043
b	1.95		2.20	0.077		0.087
c	0.15		0.40	0.006		0.016
D	3.30		3.95	0.130		0.156
E	5.10		5.60	0.201		0.220
E1	4.05		4.60	0.159		0.181
L	0.75		1.50	0.030		0.059
L1		0.40			0.016	
L2		0.60			0.024	

Figure 27. Footprint recommendations, dimensions in mm (inches)



3 Ordering Information

Table 9. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS2H100A	S21	SMA	0.068 g	5000	Tape and reel
STPS2H100AF	F21	SMA Flat	0.035 g	10 000	Tape and reel
STPS2H100AFN	A21	SMA Flat Notch	0.039 g	10 000	Tape and reel
STPS2H100U	G21	SMB	0.107 g	2500	Tape and reel
STPS2H100UF	FG21	SMB Flat	0.050 g	5000	Tape and reel

Revision history

Table 10. Document revision history

Date	Version	Changes
Jul-2003	4A	Last update.
Aug-2004	5	SMA package dimensions update. Reference A1 max. changed from 2.70 (0.106 inches) to 2.03 mm (0.080 inches).
08-Feb-2007	6	Reformatted to current standards. Added ECOPACK statement. Added SMBflat package.
15-Feb-2010	7	Updated weight for SMBflat in Table 9.
24-Jun-2013	8	Added SMAflat package
17-May-2018	9	Removed figure 6. Updated Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified) and Section Description. Minor text changes to improve readability.
08-Oct-2019	10	Added Section 2.2 SMA Flat Notch package information.

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